

Training Notification Form, IIT Delhi

Company Overview

Name: Qualcomm

Website: www.qualcomm.com

Company Type: Core (Technical)

Description: www.Qualcomm.com

Project Details

Designation: Interim Engineering Intern

Type: Core (Technical)

Location: Bangalore/Hyderabad/Chennai/Noida

Project Details: Job Area :Engineering - Software
Job Location : Hyderabad / Bangalore / Chennai / Noida
We know our employees' ideas change the world. For more than three decades, we've been a global leader in mobile technology, continually pushing the boundaries of what's possible. Working with customers across industries — from automotive to health care, from smart cities to robotics— we continue to accelerate innovation and unlock new possibilities in a time where everything is connected. By joining the Qualcomm family, you too can bring the future forward faster.
As a software engineer, you will design, develop Software for Qualcomm's mobile chipsets which are based on cutting edge technology.. Qualcomm is looking for energetic, creative and self-driven engineer to work in

- > Multimedia Technologies such as Audio and Video codecs, Image Processing,
- > Wireless Modem Technologies, such as 4G, WiFi, Bluetooth, Self-Organizing Networks.
- > Platform Level SW, such as, Linux, Android, Windows, Board Support Packages.
- > IOT Technologies, for Connected Cameras, Smart Assistants, Drones, Virtual Reality, Augmented Reality.

Campus Grads will be working on following areas:

- Development of real-time embedded software and device drivers
- Mobile SW development for Windows Mobile, Android or Linux
- Good understanding of OS concepts, Data structures, etc
- C/C++ and object oriented design
- Wireless network standards such as CDMA/GSM/UMTS/LTE
- Linux/UNIX, Linux Drivers, Linux Kernel Development
- Protocols such TCP/UDP/IP/SIP/RTP etc
- Multimedia technologies including Audio, Video, Imaging

Multimedia technologies including Audio, Video, Imaging

- Excellent analytical and problem solving skills
- Ability to collaborate and work in teams.
- Good verbal and written communication skill

Opportunities include:

- SW development for Android, Window Mobile based Embedded Platforms
- Multimedia software stack, firmware and driver Development
- Wireless Modem and connectivity Software and Firmware Development
- Communication protocol stack Software Development
- Kernel, BSP and Device Driver Development
- Application SW and UI development.
- SW Architecture for embedded devices based on Android, Windows.
- Design and development based on Object oriented programming.

Education:

Masters, Bachelors: Computer Science Engineering, Communication Engineering, ECE,

Stipend Details

Stipend:	45,000 INR Per Month
Accommodation:	Yes
Travel Expenses:	Yes

Selection Process

Resume Shortlist:	No
Written Test:	No
Online Test:	Yes
Group Discussion:	No
Personal Interview:	Yes
No. of Offers:	5

Eligibility

Diversity Recruiting:	No
Eligible Years:	Graduating in 2025 (Pre-Final Year Students) - B.Tech / Dual / Master's
Eligible Departments:	B.Tech in Computer Science & Engineering, B.Tech in Electrical Engineering, B.Tech in Electrical Engineering (Power and Automation), B.Tech in Engineering and Computational Mechanics, B.Tech in Mathematics & Computing, B.Tech and

